



REACH **ROHS** Lead Free



Features

Typical Electrical & Optical Characteristics (IF=350mA and Ta=25°C)

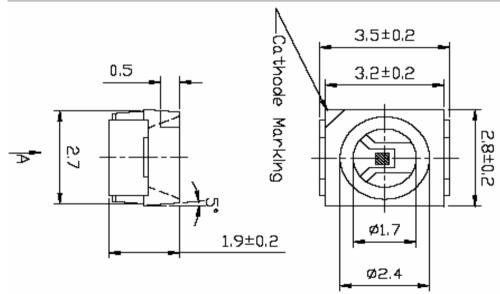
Part-No.	Dom Waveler or C0	0 ()	Forward ([\]	l Voltage √)		ous Flux cd)	Cur- rent (mA)	50% Power Angle	
	Min	Тур	Min	Max	Min	Тур	max	Тур	
M11A1307	6000 7000		3,2	3,6	2160	2660	20	120	

1. Tolerance of measurement of luminous flux : +/-15% 2. Tolerance of measurement of dominant Wavelength : +/-1nm

3. Tolerance of measurement of CCT (Correlated color temperature +/- 200K

4. Tolerance of measurement of forward voltage +/-0,1V

Technical Dimensions

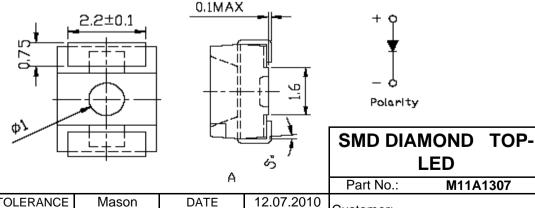


Contour Lights Garden Lighting Genral Lighting **Reading Lights**

Absulut Maximum Ratings (Ta=25°C)

Items	Symb ols	Absulut maximum Rating	Unit		
	OIS	Red			
Power Dissipation	Pd	850	mW		
Forward Current	lf	350	mA		
Peak Forward Current	lfp	500	Ma		
LED Junction Temperature	Tj	125	°C		
Operating Temperature	Topr	30°C ~ +110°C	°C		
Storage Temperature	Tstg	40°C ~ +120°C	С°		

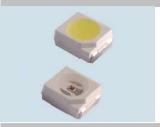
* Pulse width $\leq 0,1$ msec duty $\leq 1/10$



M11A1307 MATL: DRW: CHKD Wilson Wilson TOLERANCE 12.07.2010 Jason Customer: APPD: FINISH Sheet No. Schumi Jamy 1 from 10 www.edcon-components.com

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										BIN	GUID	E / HIG	H POW	/ER								
Code	Lu	uminous	Flux Ran	ge	Code	Lu	uminous	Flux Ran	ge				C	ode		CCT Range		Code	(CCT Rang	е	
Code	m	nin	m	ax.	Code	m	nin	m	ax.	15%				Jue	М	lin	Max	Code	Min		Max	
А		1		2	P2	7	0	8	30	- 15			/	A	27	00	2900	М	4900		5100	
В		2	2	.,5	M1	8	80	g	90	-/+ s			i	В	29	00 :	3100	Ν	5100		5500	
С	2	.,5	3	,2	M2	9	90	1	00	i xn			(С	31	00 :	3300	Р	5500		6000	
D	3	,2		4	N1	1(00	1	10	measurement of luminous Flux is			[D	33	00	3500	Q	6000		6500	
Е		4		5	N2	11	10	1:	20	nou			l	E	35	00	3700	R	6500		7000	
F		5		,2	P1	12	20	1;	30	r mi				F	37	00	3900	S	7000		7500	
G		,2	7	,7	P2	1:	30	1	40	of I			(G	39	00	4100	Т	7500		8000	
Н	7	,7	9	,6	Q1	14	40	1	50	ent			ŀ	Н	41	00	4300	U	8000		9000	
J		,6		2	Q2		50		60	rem				J	43	00	4500	V	9000		10000	
K		2		5	R1		60		70	asu			I	К	45	00	4700	W	10000		12000	
L1		5		9	R2		70		80	me				L	47		4900					
L2	1	9		24	S1	18	80	2	00	e of			Tolerand	ce of mea	surement	t of CCT is +/-10	0K.					
M1		24		30	S2		00		20	Tolerance												
M2		30		10	T1		20		40	olera												
N1		10		50	T2		40		60	Ĕ												
N2		50		60	U1	25	50	2	80													
P1	6	60		0												L.						
			В		H		/E		F		Y)/P		/U	c						
Color		Min	max	Min	max	Min	max	Min	max	Min	max	Min	max	Min	max	t of 1nn						
D		450	455	490	495	515	520	560	565	580	583	600	605	620	625	measurement of elength is +/-1nm						
D		455	460	495	500	520	525	565	570	583	586	605	610	625	630	of measuren avelength is						
D		460	465	500	505	525	530	570	575	586	589	610	615	630	635	pasu						
D	-	465	470	505	510	530	535	575	580	589	592	615	620	635	640	f me /ele						
D		470	475	510	515	535	540			592	595			640	645	e of wav						
D		475	480			540	545			595	598			645	650	ant		SM	D DIAM	OND	TOP	
D	-	480	485			545	550							650	655	Tolerance o dominant wa				ED		
D		485	490			550	555							655	660	⊢ op					1007	
D	-	ļ.,				555	560		L					660	665		40.07.00		t No.:	M11A	1307	
DR			son	CF	IKD	Wil	son		TL:		lson	TOLE	RANCE	Ma	son	DATE	12.07.20		mer:			
AP			numi	I		I		FIN	IISH	Ja	imy			I	Shee	t NO.	2 from 1					
www.e	dcon-c	ompone	ents.co	m														email: ir	nfo@edcon	i-compoi	nents.cor	

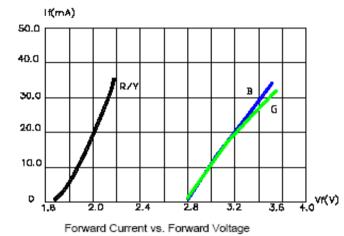
BIN GUIDE / HIGH POWER

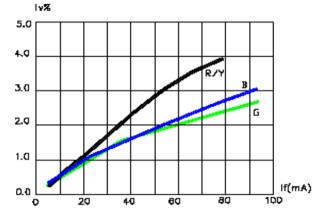
Code	CCT	Range	Code	CCT	Range
Code	Min	Max	Code	Min Ma 4900 510 5100 550 5500 600 6000 650 6500 700 7000 750 7500 800	
A	2700	2900	М	4900	5100
В	2900	3100	Ν	5100	5500
С	3100	3300	Р	5500	6000
D	3300	3500	Q	6000	6500
E	3500	3700	R	6500	7000
F	3700	3900	S	7000	7500
G	3900	4100	Т	7500	8000
Н	4100	4300	U	8000	9000
J	4300	4500	V	9000	10000
K	4500	4700	W	10000	12000
L	4700	4900			



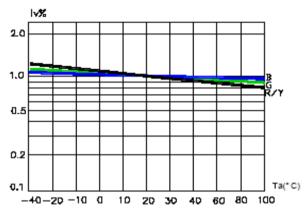


Typical Electrical / Optical Characteristics Curves (Ta=25°C Unless otherwise noted)

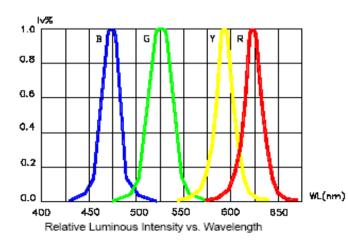








Relative Luminous Intensity vs. Ambient Temperature



CHKD

Wilson

MATL:

FINISH

Code	Forward Voltage Rank					
Code	Min.	Max.				
А	1,6	1,8				
В	1,8	2,0				
С	2,0	2,2				
D	2,2	2,4				
E	2,4	2,6				
F	2,6	2,8				
G	2,8	3,0				
Н	3,0	3,2				

Code	Forward Vo	oltage Rank		
Code	Min.	Max.		
J	3,20	3,40		
К	3,40	3,60		
L	3,60	3,80		
М	3,80	4,00		
N	4,00	4,20		
Р	4,20	4,40		
Q	4,40	4,60		
R	4,60	4,80		

A MEMBER OF EDCON-GROUP

Tolerance of measurement of forward voltage is +/-0,1V

Mason

Sheet No.

DATE

SMD DIAMOND TO LED							
	Part No.:	M11A1307					
12.07.2010	Customer:						
3 from 10							

Schumi www.edcon-components.com

Jason

DRW:

APPD:

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TOLERANCE

Wilson

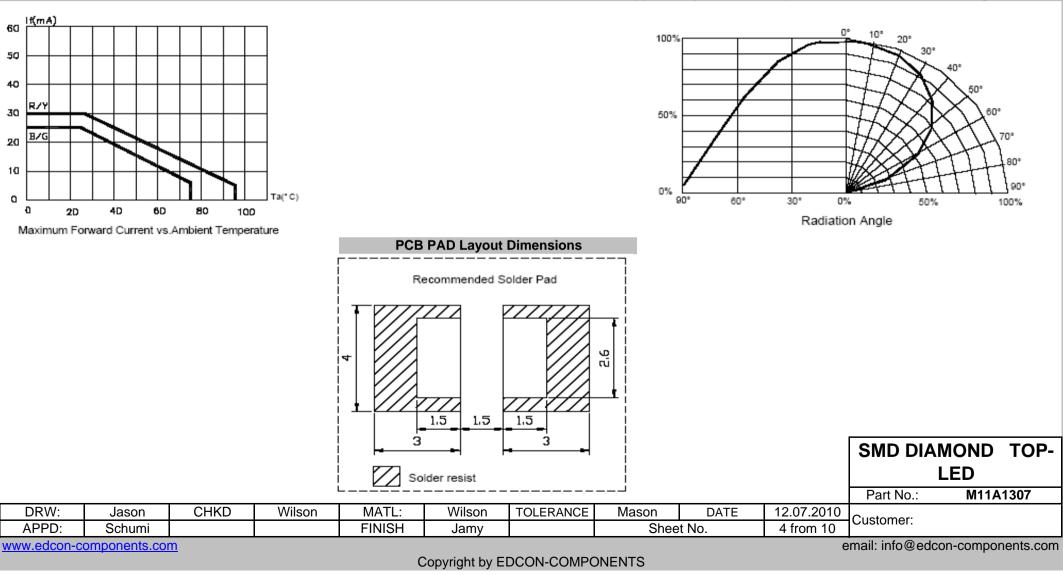
Jamy

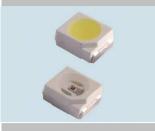
email: info@edcon-components.com





Typical Representative Spatial Radiation Paddern of single LED









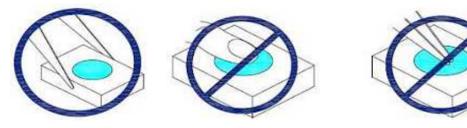


Handling Informations

- 4. The outer diameter of the TOP LED pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
- 5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although ist characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of th LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools



2. Do not directly touch or handle the silicone lens surfance. It may damage the internal circuitry.

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	\geq

3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratsch the silicone lens or damage the internal circuitry.



SMD DIAMOND	TOP-
LED	

rt	No.:	M11A1307	

Pa

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	12.07.2010	Customor
APPD:	Schumi			FINISH	Jamy		Shee	t No.	5 from 10	Customer:

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Moisture Proof Packing

In Order to prevent moisture absorption into DIAMOND = TOP LED / XEON POWER during the transportation and storage. DIAMOND TOP-LED / XEON-POWER LED is packed in a moisture barrier bag. Desiccants and humidity indicator are packed together with DIAMOND TOP-LED / XEON-POWER LED as the secondary protection. The indication of humidity card provides the information of humidity within TOP Packing.

Storage

Shelf life in original sealed bag in storage condition of <40°C and 90% RH is 12 mounths. Baking is required whenever shelf life is expired. Before opening the packaging please check wether bag leak air or not. After opening the DIAMOND TOP-LED / XEON POWER LED must be storad under the condition <30°C and 60% RH. Under this condition DIAMOND TOP-LED / XEON POWER LED must be used (subject to reflow) within 24-hours after bag opening, and re-baking is required when exceeding 24 hours. For baking, place DIAMOND TOP-LED / XEON POWER LED in oven at temperature 75°C +/-5°C and relative humidity <10%RH, for 24 hours. Take out the material from packaging bag for re-bake. Do not open the door of oven frequently during the baking process.

Manual soldering (We do not recommend this method strongly).

No mechanical stress should be exerted on the resin portion of DIAMOND TOP-LED / XEON POWER during soldering.

Handling of DIAMOND TOP-LED / XEON POWER LED should be done when the package has been cooled down to below 40°C or less. This is to prevent the DIAMOND

TOP-LED / XEON POWER failures due the thermal-mechanical strss during handling.

Reflow soldering should not be done more than one time.

No stress should be exerted on the package during soldering.

Electrostatic Discharge and Surge current.

Electrostatic discharge (ESD) or surge current (EOS) may damage LED.

Precautions such as ESD wrist strap, ESD shoe strap or antistatic gloves must be worn whenever handling DIAMOND TOP-LED / XEON POWER LED.

All devices, equipment and machinery must be prpertly grounded.

It is recommended to perform electrical test to screen out ESD failures in final inspection.

It is importate to eliminate the possibility of surge current during circuity design.

Heat Management

Heat management of DIAMOND TOP-LED / XEON POWER must be taken into into consideration during the design stage of DIAMOND TOP-LED / XEON POWER LED application. The current should be de-rated appropriately by refering to the de-rating curve attached on each product specification.

										SMD DIA	LED
										Part No.:	M11A1307
DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	12.07.2010 6 from 10	Customori	
APPD:	Schumi			FINISH	Jamy		Shee	t No.	6 from 10	Customer.	
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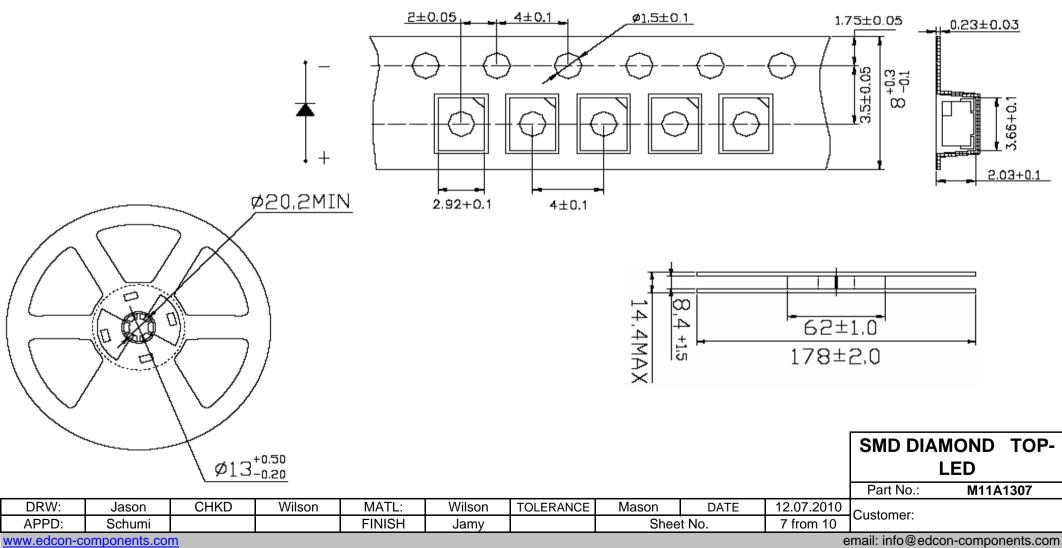
email: inio@eucon-components.com







Packing Specifications



EDCON-COMPONENTS RoHS Lead Free REACH COMPONENTS The Power of LED Light A MEMBER OF EDCON-GROUP **Ordering Informations**

Serie	Color Code	ROHS	Packing				
M11A1307	WH	R	TR				

WH= White	R = ROHS Conform	TR= TAPE REEL			
	N= NON	BU= Bulk-			
	ROHS	Ware			

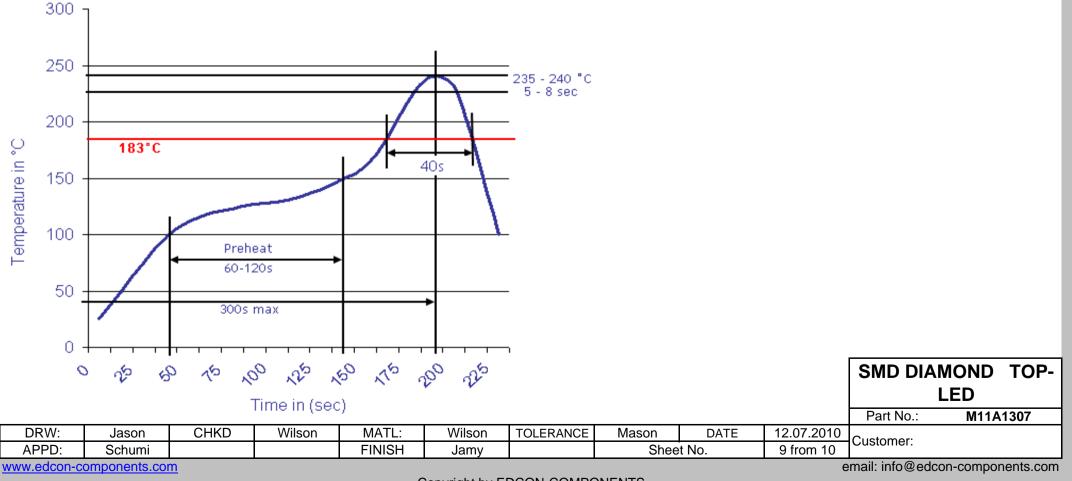
										SMD DIAMOND TOP- LED	
										Part No.:	M11A1307
DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	12.07.2010	Customer:	
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Classification Reflow Profile (JEDEC J-STD-020C)





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Spectral Color Curve

